



# Product data sheet

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### Features

Ideal for printed circuit board

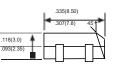
Reliable low cost construction utilizing molded plastic technique

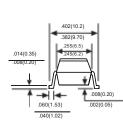
High temperature soldering guaranteed: 260°/10 seconds at 5 lbs., (2.3kg) tension Small size, simple installation

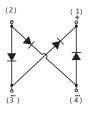
High surge current capability

## **Mechanical Data**

Case : JEDEC DBS Molded plastic body Terminals : Solder plated, solderable per MIL-STD-750, Method 2026 Polarity : Polarity symbol marking on case Mounting Position : Any Weight : 0.02 ounce, 0.4 grams







Dimensions in inches and (millimeters)

#### **REEL SPECIFICATION**

P/N	PKG	QTY
DB201S-DB207S	DBS	1500

## **Maximum Ratings And Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwisespecified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

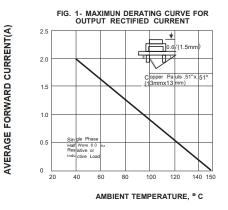
Parameter	SYMBOLS	DB201S	DB202S	DB203S	DB204S	DB205S	DB206S	DB207S	UNITS
Marking Code		DB201S	DB202S	DB203S	DB204S	DB205S	DB206S	DB207S	
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS voltage	Vrms	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_c$ =40°C	IF(AV)	2.0							А
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	Ifsm	60						A	
Maximum instantaneous forward voltage drop per leg at 1A	Vf	1.1						V	
Maximum DC reverse currentTa=25°Cat rated DC blocking voltageTa=100°C	R	10 500						μA μA	
Operating temperature range	TJ	-55 to +150						°C	
storage temperature range	Тѕтс	-55 to +150						°C	

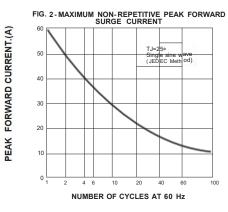
NOTES:DBS for surface mount package.

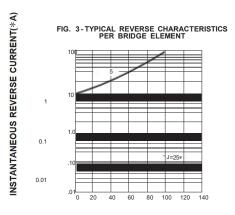




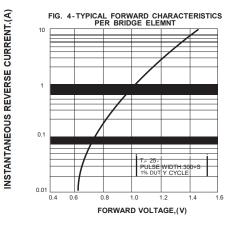
Semiconductor Compiance



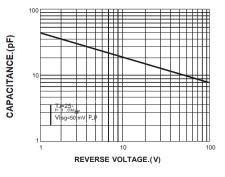




PERCENT OF RATED PEAK REVERSE VOLTAGE.(%)









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